PRODUCT BRIEF

CoolSET F2 expands its family Now also available in TO-220-6 & DIP-7 !

Description:

Second generation of integrated Power ICs for switched mode power supplies (SMPS).

BY IN TEG R AT IN G a pulse width modulator control IC and CoolMOS[™] power MOSFET into one package, CoolSET[™] marks a new dimension in design agility and miniaturization. At the same time, the CoolSET family provides the highest output power with the lowest losses available in industry. CoolSET additionally integrates a very low power standby concept which reduces the power dissipation in standby mode.

N O W CoolSET is also available with 67kHz operating frequency the ,B' version. The CoolSET family is offered in 3 packages broadening the power range up to 180W at wide range voltage input. Simultanously the new packages are with improved creepage distance.



Applications:

Switched Mode Power Supplies (SMPS) for:

- Adapters
 - Notebooks
 - Printers
 - LCD-Monitors

Battery Chargers for Portables

- Mobile Phones
- Digital Still Cameras
- Personal Digital Assistants Organizers
- Battery Operated Tools
- Set-Top-Boxes
- Digital Video Disc Players / Recorders

As well as Standby / Auxillary Power Supplies for:

- PC
- White goods
- USB



COOISET F2

ICE2xxxxx series www.infineon.com/coolset



Never stop thinking

Benefits:

Integrated Power IC

Features:

- 650V and 800V avalanche rugged CoolMOS[™] technology
- Enhanced integrated protection functions
- Modulated gate drive
- · External current sense
- TO-220-6

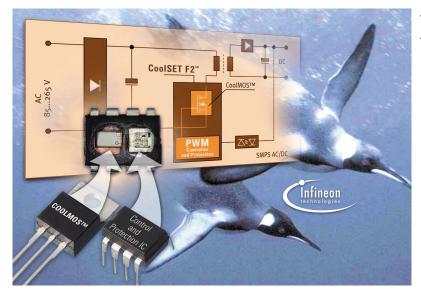
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- - - · Lowest standby power dissipation

 - Packages DIP-8, DIP-7,

- Easier SMPS Design
- Reduced heat generation
- Reduced system cost, size and weight
- Less external components
- Comply with standby power requirements
- Reduced EMI
- Flexibility in current limitation
- · Optimized fit for each application
- Increased creepage distance

PRODUCT BRIEF



Typical Application Example: AC/DC Flyback Converter

V _{DS}	f _{OPER}	Туре	R _{DS(on)}	P _{OUT(max.)} ¹⁾	Package
[V]	[kHz]		[Ω]	[W]	
650	100	ICE2A0565	6.0	15	P-DIP-8-6
		ICE2A0565Z	6.0	13	P-DIP-7-1
		ICE2A165	3.0	21	P-DIP-8-6
		ICE2A265	1.0	34	P-DIP-8-6
		ICE2A365	0.5	47	P-DIP-8-6
650	67	ICE2B165	3.0	21	P-DIP-8-6
		ICE2B265	1.0	34	P-DIP-8-6
		ICE2B365	0.5	47	P-DIP-8-6
800	100	ICE2A180	3.0	21	P-DIP-8-6
		ICE2A280	0.8	37	P-DIP-8-6
		ICE2A180Z	3.0	19	P-DIP-7-1
		ICE2A280Z	0.8	33	P-DIP-7-1
V _{DS} [V]	f _{OPER} [kHz]	Туре	R _{DS(on)} [Ω]	P _{OUT(max.)} ²⁾ [W]	Package
650		ICE2A765P	0.5		P-TO220-6 ISO
650		ICE2B765P	0.5		P-TO220-6 ISO

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• Pout ~10...45W standard DIP8 package



NEW!

P-DIP-7

• Pout ~10...35W · increased creepage distance

TO-220-6 Isolated

- Pout ~50W...200W
- isolated lead frame
- increased creepage
- distance

¹⁾ R_{th}=56k/W (~6cm² copper area), T_a=50°C, T_i=125°C, V_{in}=85V...270V

²⁾ R_{th}=2,7k/W, T_a=50°C, T_i=125°C,V_{in}=85V...270V

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